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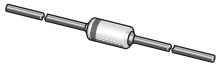
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Kind regards,

Team Nexperia



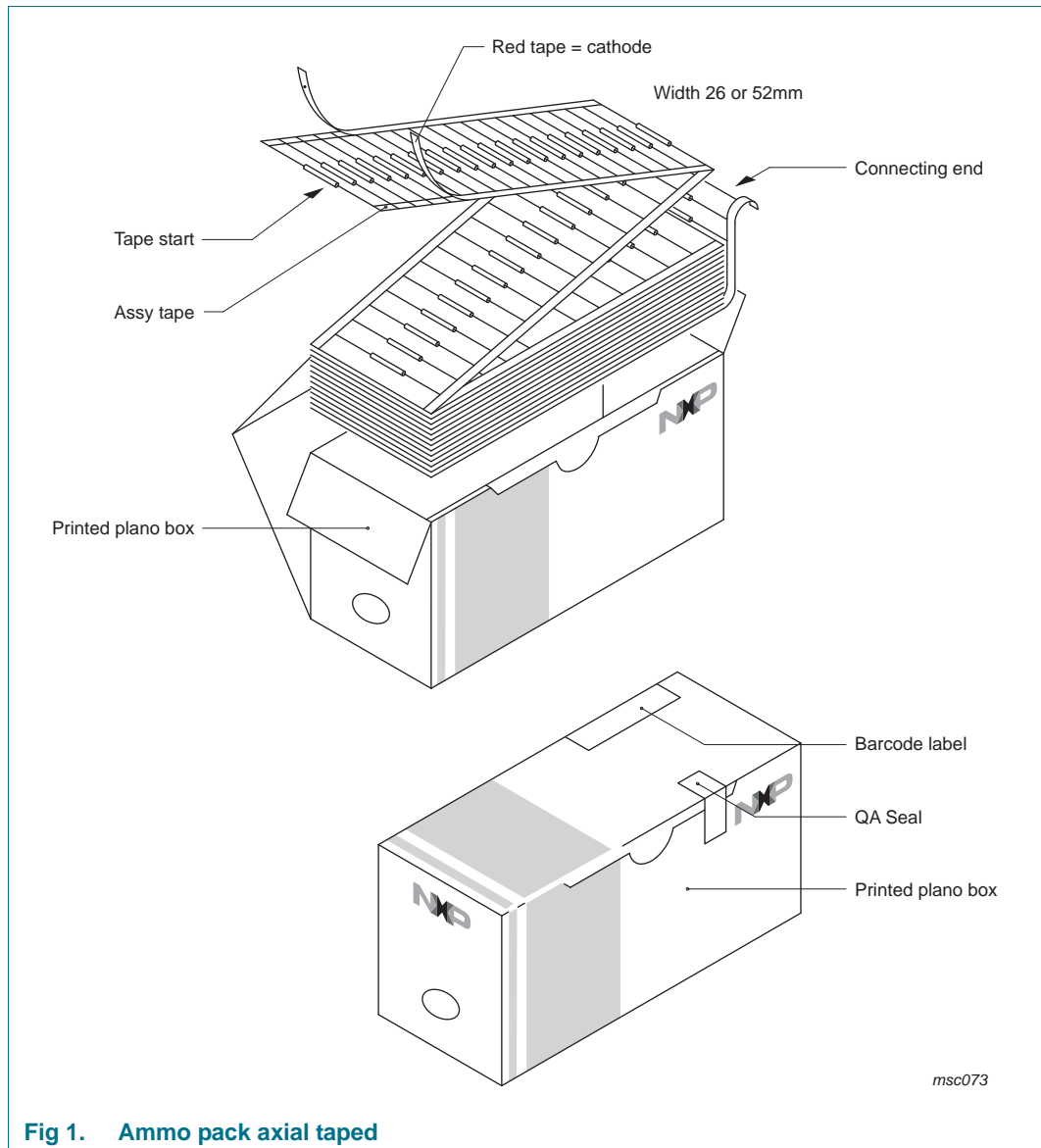
# SOD27

**Ammo pack axial taped; standard product orientation 12NC ending 133**

Rev. 1 — 12 October 2012

Packing information

## 1. Packing method



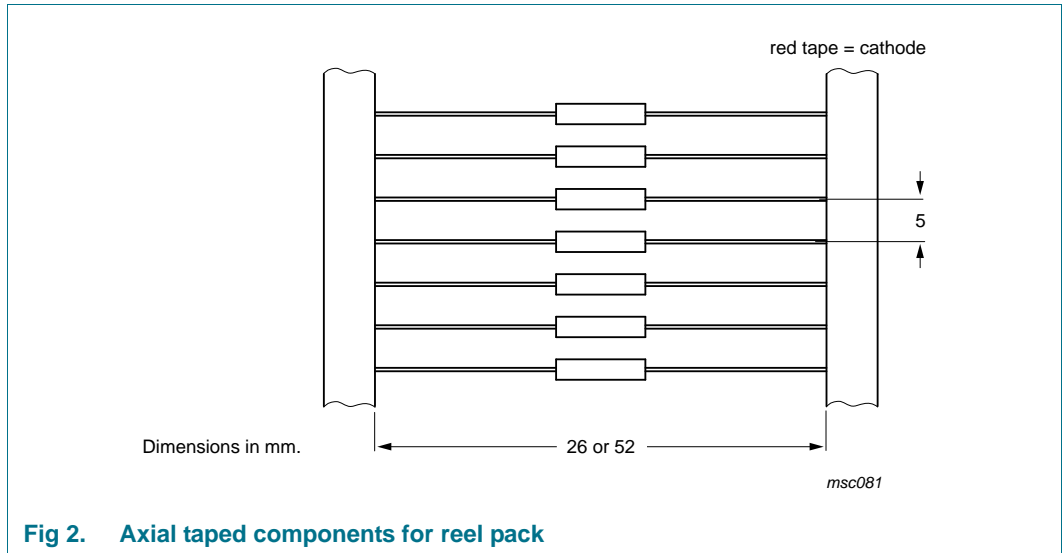
**Fig 1. Ammo pack axial taped**

**Table 1. Packing information**

Package version	12NC ending	Taping width (mm)	Taping method	SPQ/PQ (pcs)	Outer box dimensions l x w x h (mm)
SOD27	133	52	axial	10000	263 x 73 x 124



## 2. Product orientation



**Fig 2. Axial taped components for reel pack**

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